

ESD Protection Diodes with Ultra Low Capacitance

The FTV05LVUUL2 is designed to protect voltage sensitive components that require ultra-low capacitance from ESD and transient voltage events. Excellent clamping capability, low capacitance, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed and antenna line applications.

Specification Features:

- Ultra Low Capacitance 0.5 pF
- Low Clamping Voltage
- Small Body Outline Dimensions: 0.039"x 0.024"(1.00 mm x 0.60 mm)
- Low Body Height: 0.020"(0.5 mm)
- Stand-off Voltage: 5 V
- · Low Leakage
- Response Time is Typically < 1.0 ns
- IEC61000-4-2 Level 4 ESD Protection
- This is a Pb-Free Device

SOD-882

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ANODE

Ordering information

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CATHODE

Device	Marking	Shipping		
FTV05LVUUL2	М	10000/Tape&Reel		

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic Epoxy Meets UL 94 V-0 **LEAD FINISH:** 100% Matte Sn (Tin)

Qualified max Reflow Temperature: 260°C

Device Meets MSL 1 Requirements

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Contact Air		±10 ±15	kV
Total Power Dissipation on FR−5 Board (Note 1) @ T _A = 25°C	P _D	150	mW
Storage Temperature Range	T _{stg}	-55 to +150	°C
Junction Temperature Range	ТJ	-55 to +125	°C
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

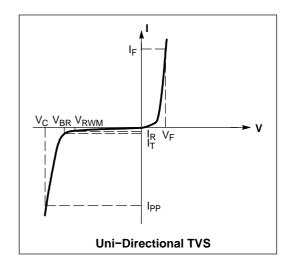
1. FR-5 = 1.0 x 0.75 x 0.62 in.



ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

Symbol	Parameter					
I _{PP}	Maximum Reverse Peak Pulse Current					
V _C	Clamping Voltage @ IPP					
V _{RWM}	Working Peak Reverse Voltage					
I _R	Maximum Reverse Leakage Current @ V_{RWM}					
V _{BR}	Breakdown Voltage @ I _T					
Ι _Τ	Test Current					
١ _F	Forward Current					
V _F	Forward Voltage @ I _F					
P _{pk}	Peak Power Dissipation					
С	Capacitance @ $V_R = 0$ and f = 1.0 MHz					



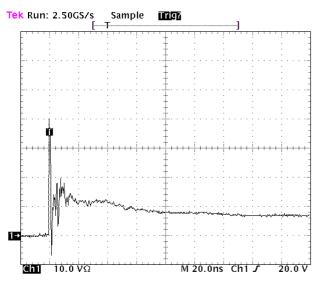
ELECTRICAL CHARACTERISTICS

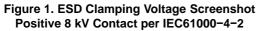
(T_A = 25°C unless otherwise noted, V_F = 1.0 V Max. @ I_F = 10 mA for all types)

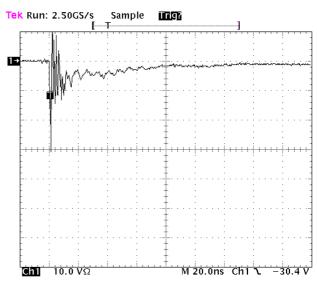
		V _{RWM} (V)	I _R (uA) @ V _{RWM}	V _{BR} (V) @ I _T (Note 2)	ե	C (pF)	V _C (V) @ I _{PP} = 1 A (Note 3)	v _c
Device	Device Marking	Max	Max	Min	mA	Max	Мах	Per IEC61000-4-2 (Note 4)
FTV05LVUUL2	Μ	5.0	1.0	5.4	1.0	1.5	9.8	Figures 1 and 2 See Below

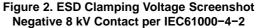
2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

3. Surge current waveform per Figure 5.









First Silicon

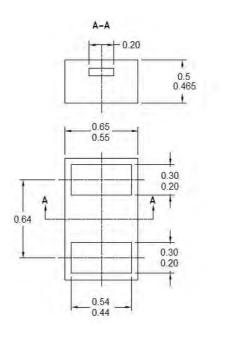


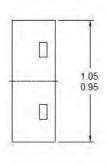
FTV05LVUUL2

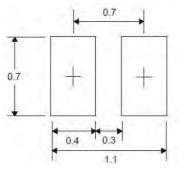
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DIMENSION OUTLINE:

Unit:mm







Revision No: 0